

Single N-channel MOSFET

ELM13416CA-S

■ General description

ELM13416CA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and operation with gate voltages as low as 1.8V and internal ESD protection is included.

■ Features

- $V_{ds}=20V$
- $I_d=6.5A$ ($V_{gs}=4.5V$)
- $R_{ds(on)} < 22m\Omega$ ($V_{gs}=4.5V$)
- $R_{ds(on)} < 26m\Omega$ ($V_{gs}=2.5V$)
- $R_{ds(on)} < 34m\Omega$ ($V_{gs}=1.8V$)
- ESD Rating : 2000V HBM

■ Maximum absolute ratings

Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	20	V	
Gate-source voltage	V_{gs}	± 8	V	
Continuous drain current	I_d	6.5	A	1
		5.2		
Pulsed drain current	I_{dm}	30	A	2
Power dissipation	P_d	1.4	W	1
		0.9		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

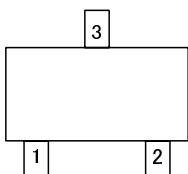
■ Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	65	90	°C/W	1
Maximum junction-to-ambient	Steady-state		85	125	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	43	60	°C/W	3

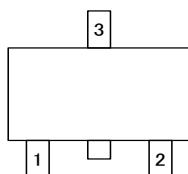
■ Pin configuration

■ Circuit

SOT-23 (TOP VIEW)

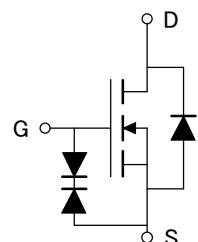


(Without extra bar)



(With extra bar)

Pin No.	Pin name
1	GATE
2	SOURCE
3	DRAIN



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■ Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BVdss	$I_d=250\mu A, V_{gs}=0V$	20			V
Zero gate voltage drain current	Idss	Vds=16V			1	μA
		Vgs=0V	Tj=55°C		5	μA
Gate-body leakage current	Igss	Vds=0V, Vgs=±4.5V			±1	μA
		Vds=0V, Vgs=±8V			±10	μA
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250 μA	0.4	0.6	1.0	V
On state drain current	Id(on)	Vgs=4.5V, Vds=5V	30			A
Static drain-source on-resistance	Rds(on)	Vgs=4.5V		18	22	$m\Omega$
		Id=6.5A	Tj=125°C	25	30	$m\Omega$
		Vgs=2.5V, Id=5.5A		21	26	$m\Omega$
		Vgs=1.8V, Id=5A		26	34	$m\Omega$
Forward transconductance	Gfs	Vds=5V, Id=6.5A		29		S
Diode forward voltage	Vsd	Is=1A, Vgs=0V		0.76	1.00	V
Max. body-diode continuous current	Is				2.5	A
DYNAMIC PARAMETERS						
Input capacitance	Ciss	Vgs=0V, Vds=10V, f=1MHz		1160		pF
Output capacitance	Coss			187		pF
Reverse transfer capacitance	Crss			146		pF
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		1.5		Ω
SWITCHING PARAMETERS						
Total gate charge	Qg	Vgs=4.5V, Vds=10V, Id=6.5A		16.0		nC
Gate-source charge	Qgs			0.8		nC
Gate-drain charge	Qgd			3.8		nC
Turn-on delay time	td(on)	Vgs=5V, Vds=10V Rl=1.5 Ω , Rgen=3 Ω		6.2		ns
Turn-on rise time	tr			12.7		ns
Turn-off delay time	td(off)			51.7		ns
Turn-off fall time	tf			16.0		ns
Body diode reverse recovery time	trr	If=6.5A, dl/dt=100A/ μs		17.7		ns
Body diode reverse recovery charge	Qrr	If=6.5A, dl/dt=100A/ μs		6.7		nC

NOTE :

1. The value of $R\theta_{ja}$ is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with $T_a=25^\circ C$. The value in any given applications depends on the user's specific board design, The current rating is based on the $t \leq 10s$ thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The $R\theta_{ja}$ is the sum of the thermal impedance from junction to lead $R\theta_{jl}$ and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_a=25^\circ C$. The SOA curve provides a single pulse rating.

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■ Typical electrical and thermal characteristics

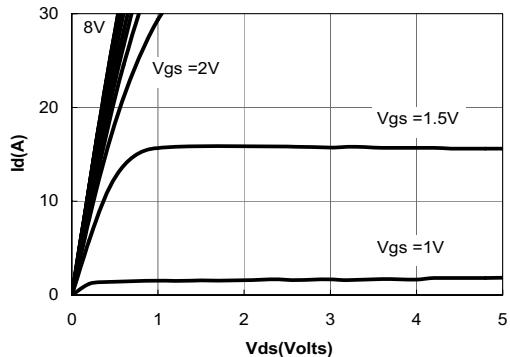


Figure 1: On-Regions Characteristics

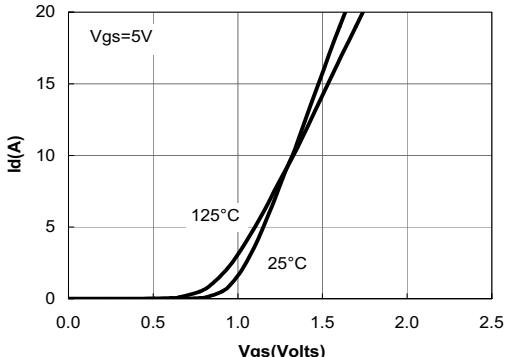


Figure 2: Transfer Characteristics

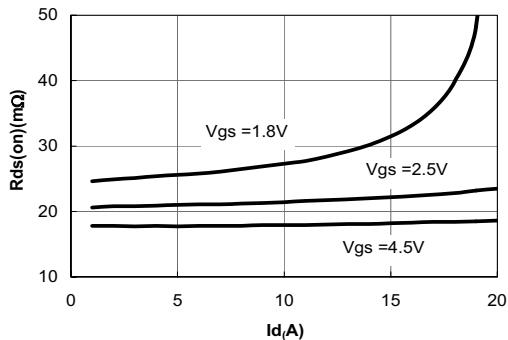


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

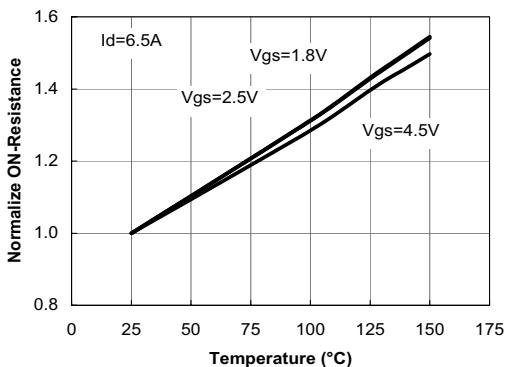


Figure 4: On-Resistance vs. Junction Temperature

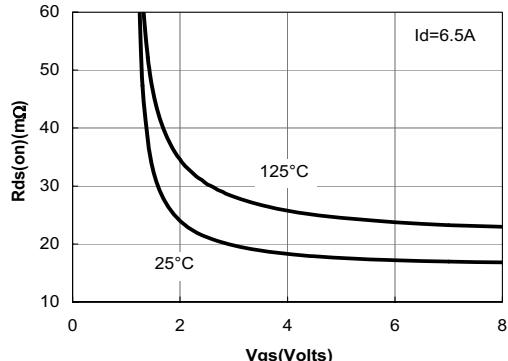


Figure 5: On-Resistance vs. Gate-Source Voltage

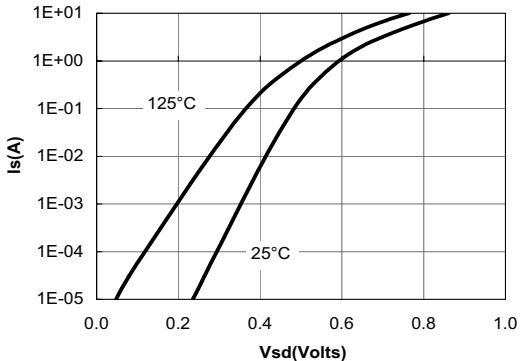


Figure 6: Body-Diode Characteristics

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